

### 3.0Amp Standard Silicon Rectifiers

DO-27

### **Features**

- → The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Open Junction chip
- Low reverse leakage
- High forward surge current capability
- → High temperature soldering guaranteed 250°C/10 seconds at terminals

### **Mechanical Data**

Case: Molded plastic body

Terminals: Solder plated, solderable per MIL-STD-750, Method 2026

Polarity: Polarity symbol marking on body

Mounting Position: Any

Weight: 0.0345 ounce, 0.98 grams

# 0.945 (24.0) MIN. 0.945 (24.0) MIN. 0.375(9.5) 0.285(7.2) 0.945 (24.0) MIN. 0.945 (24.0) MIN.

Dimensions in inches and (millimeters)

# **Maximum Ratings And Electrical Characteristics**

Ratings at  $25\,^{\circ}$ C ambient temperature unless otherwise specified. Single phase half-wave 60Hz,resistive or inductive load, for capacitive load current derate by 20%.

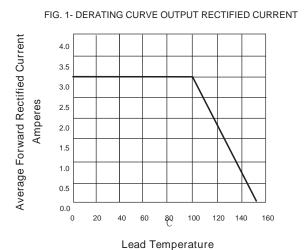
Parameter	SYMBOLS	1N 5400	1N 5401	1N 5402	1N 5403	1N 5404	1N 5405	1N 5406	1N 5407	1N 5408	UNITS
Maximum repetitive peak reverse voltage	Vrrm	50	100	200	300	400	500	600	800	1000	V
Maximum RMS voltage	Vrms	35	70	140	210	280	350	420	560	700	V
Maximum DC blocking voltage	VDC	50	100	200	300	400	500	600	800	1000	V
Maximum average forward rectified current at TL=100°C	I(AV)	3.0					A				
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	IFSM	150.0					A				
Maximum instantaneous forward voltage at 3.0A	VF						V				
Maximum DC reverse current T A =25°C at rated DC blocking voltage TA=125°C	IR	10.0 500					u A				
Typical junction capacitance (Note1)	Сл	50.0					pF				
Typical thermal resistance	RqJA	45.0					°C/W				
Operating junction and storage temperature range	Tj,Tstg	-55 to +150					°C				

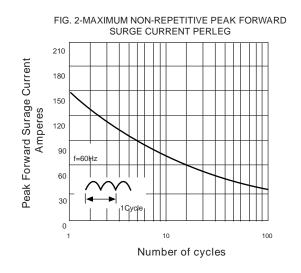
Note: 1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

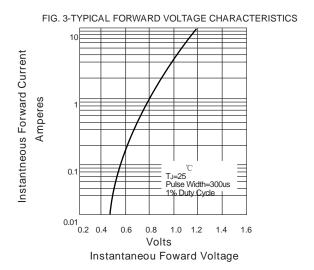


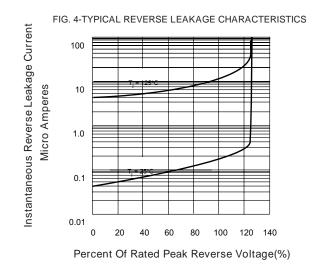
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# **Ratings And Characteristic Curves**





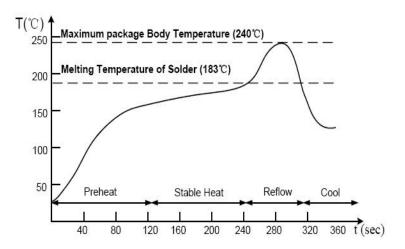






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### **Suggested Soldering Temperature Profile**

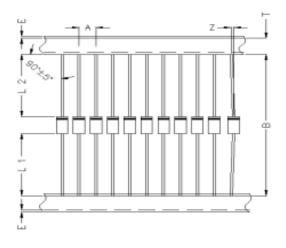


#### Note

- ◆ Recommended reflow methods: IR, vapor phase oven, hot air oven, wave solder.
- → The device can be exposed to a maximum temperature of 265°C for 10 seconds.
- → Devices can be cleaned using standard industry methods and solvents.
- → If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

## **Package Information**

#### **Taping Specifications**



Item	Symbol	Specifications(mm)			
Component Pitch	A	10.0±0.5			
Inner Tape Pitch	В	52.4±1.5			
Component alignment	Z	1.2 Max			
Tape width	Т	6.0±0.5			
Exposed adhesive	Е	0.8 Max			
Body eccentricity	L1-L2	1.0 Max			

#### **Ammunition Package Specifications**

Package	Inner Box Size	QTY/Box	Carton Size	Q'TY/Carton		
	(mm)	(Kpcs)	(mm)	(Kpcs)		
DO - 27	255*150*75	1.25	420*276*312	12.5		



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